CUSTOMER: DATE:

纳入仕样书
SPECIFICATION

RoHS+HSF
COMPLIANT

产 品 名 称 PRODUCT NAME: 叠层片式陶瓷电感

Multilayer Chip Ceramic Inductor

贵 司 料 号 YOUR PART NO.:

敝 司 料 号 OUR PART NO.: MGCI0603HQ Type

版本号 VERSION NO.: V1.1

接受 RECEPTION THE SPECIFICATION HAS BEEN ACCEPTED. 该纳入仕样书已被我司接受 日期: DATE： 公司： COMPANY：

批准 CFMD	审核 CHKD	接收 RCVD

本纳入仕样书共 18 页

MANUFACTURING NAME

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纳入仕样书改定履历 MODIFY HISTORY OF SPECIFICATION

O.	DATE	CONTENT	REV	APPROVED
1	2020.03.31	初稿:制定 First draft: formulation	1.0	陈鑫
2	2022.07.01	二稿:更新测量设备型号 Second draft: Update the model of measuring equipment	1.1	陈鑫

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1 适用范围 Scope

本纳入仕样书适用于 MGCI 系列片式陶瓷电感。

This specification applies to the MGCI series of multilayer chip ceramic inductors.

2 品名构成 Product Identification

MGCI	0603	HQ	1N0	□	T	- LF
①	②	③	④	⑤	⑥	⑦

① 产品系列 Product Symbol

② 产品尺寸 Dimensions（见 3）

③ 基本材料代码 Material Code（陶瓷材料 HQ,）

④ 电感量 Inductance Value(1N0: 1.0nH)

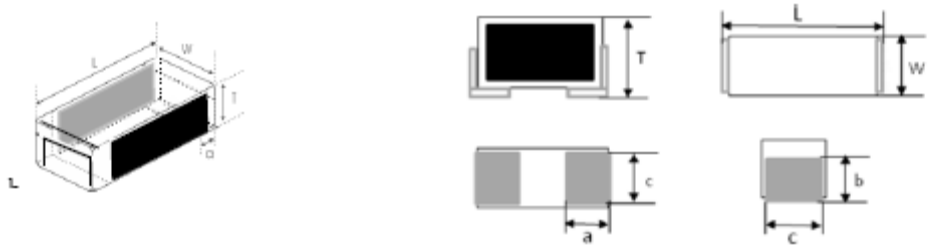
⑤ 允许容差 Inductance Tolerance(B:±0.1nH;C:±0.2nH;S:±0.3nH;D:±0.5nH; H:±3%;J:±5%;)

⑥ 包装方式（B：散装；T：盘装）Packaging Style (B: Bulk; T: Tape & Reel)

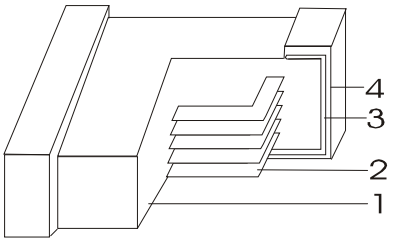
⑦ 环保标识 Lead Free

3 形状、尺寸、材料和焊盘 Appearance, Dimensions, Material and Recommended

Unit: mm [inch]



Type 型号	Dimensions (mm) [inch]					
	L长	W宽	T高	a	b	c
0603 [0201]	0.60±0.03 [0.024±0.0012]	0.30±0.03 [0.012±0.0012]	0.40±0.03 [0.016±0.0012]	0.15±0.03 [0.006±0.001]	0.20±0.03 [0.008±0.001]	0.25±0.03 [0.01±0.001]



	构成 Composition	材料 Material
1	基体材料 Base Material	陶瓷材料 Ceramic Material
2	内导体 Internal Conductor	银 Ag
3	端电极 Terminal Electrode	银 Ag
4	端电极 Terminal Electrode	镍-锡 Ni-Sn

4 测试条件 Testing Conditions

除非另有规定，否则在以下条件下测试 <Unless otherwise specified>

温度 Temperature : Ordinary Temperature (5 to 35℃)

湿度 Humidity : Ordinary Humidity (25 to 85% RH)

大气压强 Atmospheric Pressure : 86 to 106 kPa

当对测量结果有疑问时<In case of doubt>

温度 Temperature : 20±2℃

湿度 Humidity : 60 to 75% RH

大气压强 Atmospheric Pressure : 86 to 106 kPa

5 标称值 Rating

操作温度范围 Operating Temperature Range : -55 to +125℃

保存温度范围 Storage Temperature Range : -55 to +125℃

CUST Part No.	MG Part No.	L (nH)	Q min	L,Q Test Freq. (MHz)	Q 500 MHz Typ	Q 800 MHz Typ	Q 1800 MHz Typ	Q 2000 MHz Typ	Q 2400 MHz Typ	SRF (min) MHz	Rdc (MAX) (Ω)	Ir(mA) (max)
	MGCI0603HQ0N6□T-LF	0.6	20	500	-	-	-	-	-	20000	0.04	1100
	MGCI0603HQ0N7□T-LF	0.7	20	500	-	-	-	-	-	20000	0.04	1100
	MGCI0603HQ0N8□T-LF	0.8	20	500	-	-	-	-	-	18000	0.04	1100
	MGCI0603HQ0N9□T-LF	0.9	20	500	-	-	-	-	-	18000	0.04	1100
	MGCI0603HQ1N0□T-LF	1.0	20	500	47	60	92	99	110	16000	0.04	1100
	MGCI0603HQ1N1□T-LF	1.1	20	500	46	58	90	95	104	14000	0.04	1100
	MGCI0603HQ1N2□T-LF	1.2	20	500	45	56	88	92	100	13000	0.04	1100
	MGCI0603HQ1N3□T-LF	1.3	20	500	45	56	88	93	102	13000	0.04	1100
	MGCI0603HQ1N4□T-LF	1.4	20	500	42	55	89	95	103	12000	0.04	1100
	MGCI0603HQ1N5□T-LF	1.5	20	500	42	54	86	90	100	12000	0.05	1000
	MGCI0603HQ1N6□T-LF	1.6	20	500	41	52	80	83	92	10000	0.05	1000
	MGCI0603HQ1N7□T-LF	1.7	20	500	39	49	75	79	86	10000	0.07	800
	MGCI0603HQ1N8□T-LF	1.8	20	500	38	45	72	75	81	10000	0.08	800
	MGCI0603HQ1N9□T-LF	1.9	20	500	36	46	71	74	81	10000	0.12	600
	MGCI0603HQ2N0□T-LF	2.0	20	500	36	45	68	70	77	9000	0.12	600
	MGCI0603HQ2N1□T-LF	2.1	20	500	36	45	67	71	76	9000	0.12	600
	MGCI0603HQ2N2□T-LF	2.2	20	500	36	45	67	69	76	9000	0.12	600
	MGCI0603HQ2N3□T-LF	2.3	20	500	37	46	68	71	76	9000	0.12	600
	MGCI0603HQ2N4□T-LF	2.4	20	500	39	48	72	75	82	9000	0.12	600
	MGCI0603HQ2N5□T-LF	2.5	20	500	38	47	70	73	80	9000	0.12	600
	MGCI0603HQ2N6□T-LF	2.6	20	500	35	43	64	66	72	9000	0.12	600
	MGCI0603HQ2N7□T-LF	2.7	20	500	36	44	65	68	73	9000	0.12	600
	MGCI0603HQ2N8□T-LF	2.8	20	500	34	43	63	65	70	8000	0.12	600
	MGCI0603HQ2N9□T-LF	2.9	20	500	36	45	65	66	72	8000	0.12	600
	MGCI0603HQ3N0□T-LF	3.0	20	500	36	44	65	66	72	8000	0.12	600
	MGCI0603HQ3N1□T-LF	3.1	20	500	34	42	62	64	69	7500	0.17	500
	MGCI0603HQ3N2□T-LF	3.2	20	500	33	42	63	66	72	7000	0.17	500
	MGCI0603HQ3N3□T-LF	3.3	20	500	34	45	73	77	89	7000	0.17	500
	MGCI0603HQ3N4□T-LF	3.4	20	500	33	41	59	61	66	7000	0.17	500
	MGCI0603HQ3N5□T-LF	3.5	20	500	33	41	59	61	65	7000	0.17	500
	MGCI0603HQ3N6□T-LF	3.6	20	500	32	42	59	61	65	7000	0.17	500
	MGCI0603HQ3N7□T-LF	3.7	20	500	32	40	59	60	65	7000	0.17	500
	MGCI0603HQ3N8□T-LF	3.8	20	500	31	38	60	62	70	7000	0.17	500
	MGCI0603HQ3N9□T-LF	3.9	20	500	30	39	61	64	72	7000	0.17	500
	MGCI0603HQ4N0□T-LF	4.0	20	500	33	41	59	61	66	7000	0.17	500
	MGCI0603HQ4N1□T-LF	4.1	20	500	30	38	56	58	62	7000	0.17	500
	MGCI0603HQ4N2□T-LF	4.2	20	500	31	39	57	59	63	7000	0.17	500
	MGCI0603HQ4N3□T-LF	4.3	20	500	32	40	58	59	64	7000	0.17	500
	MGCI0603HQ4N7□T-LF	4.7	20	500	31	39	58	58	63	7000	0.25	400
	MGCI0603HQ5N1□T-LF	5.1	20	500	32	39	55	56	59	5500	0.25	400
	MGCI0603HQ5N6□T-LF	5.6	20	500	32	40	56	57	57	5500	0.25	400
	MGCI0603HQ6N2□T-LF	6.2	20	500	29	36	51	52	55	5500	0.25	400
	MGCI0603HQ6N8□T-LF	6.8	20	500	29	36	50	51	53	5500	0.30	400
	MGCI0603HQ7N5□T-LF	7.5	20	500	28	36	50	52	53	4500	0.30	400
	MGCI0603HQ8N2□T-LF	8.2	20	500	29	37	51	51	52	4500	0.40	300

	MGCI0603HQ9N1□T-LF	9.1	20	500	27	35	48	50	51	4500	0.40	300
	MGCI0603HQ10N□T-LF	10	20	500	28	36	48	49	47	4500	0.40	300
	MGCI0603HQ11N□T-LF	11	20	500	28	36	48	49	47	4000	0.50	300
	MGCI0603HQ12N□T-LF	12	20	500	29	36	48	49	48	4000	0.50	300
	MGCI0603HQ13N□T-LF	13	20	500	28	35	45	46	43	4000	0.50	300
	MGCI0603HQ15N□T-LF	15	20	500	27	34	41	40	37	3500	0.7	300
	MGCI0603HQ16N□T-LF	16	20	500	27	34	41	40	36	3500	0.8	250
	MGCI0603HQ18N□T-LF	18	20	500	28	35	41	39	35	3500	0.8	250
	MGCI0603HQ20N□T-LF	20	20	500	26	33	38	37	30	3000	0.8	250
	MGCI0603HQ22N□T-LF	22	20	500	25	31	35	33	29	3000	0.82	250
	MGCI0603HQ24N□T-LF	24	15	500	27	32	32	29	22	2000	1.6	170
	MGCI0603HQ27N□T-LF	27	15	500	25	30	29	25	17	2000	1.6	170
	MGCI0603HQ30N□T-LF	30	12	500	27	31	26	21	11	1700	2.0	150
	MGCI0603HQ33N□T-LF	33	12	300	26	31	23	19	8	1700	2.0	150
	MGCI0603HQ36N□T-LF	36	12	300	25	28	20	13	-	1500	2.0	150
	MGCI0603HQ39N□T-LF	39	12	300	25	29	17	11	-	1500	2.0	150
	MGCI0603HQ43N□T-LF	43	12	300	25	28	15	10	-	1300	2.5	130
	MGCI0603HQ47N□T-LF	47	12	300	25	28	14	7	-	1300	2.5	130
	MGCI0603HQ51N□T-LF	51	12	300	25	29	12	6	-	1200	2.5	130
	MGCI0603HQ56N□T-LF	56	12	300	22	25	7	1	-	1200	2.5	130
	MGCI0603HQ62N□T-LF	62	12	300	21	24	2	-	-	1100	5.0	100
	MGCI0603HQ68N□T-LF	68	12	300	21	24	2	-	-	1100	5.0	100
	MGCI0603HQ75N□T-LF	75	10	300	21	24	1	-	-	1100	5.0	100
	MGCI0603HQ82N□T-LF	82	10	300	20	20	-	-	-	1000	5.0	100
	MGCI0603HQ91N□T-LF	91	10	300	19	19	-	-	-	1000	7.0	80
	MGCI0603HQR10□T-LF	100	10	300	18	17	-	-	-	900	7.0	80
	MGCI0603HQR11□T-LF	110	10	300	18	17	-	-	-	900	8.0	80
	MGCI0603HQR12□T-LF	120	10	300	18	17	-	-	-	800	8.0	80
	MGCI0603HQR13□T-LF	130	7	100	16	14	-	-	-	700	8.0	80
	MGCI0603HQR15□T-LF	150	7	100	16	13	-	-	-	700	8.0	80

Note: □: Please specify the inductance tolerance. For L≤4.2nH, choose B=±0.1nH, C=±0.2nH or S=±0.3nH; For L＞4.2nH choose, H=±3%, J=±5%.

6 电气特性 Electrical Performance

6.1 电感量；Q 值 Inductance；Q factor

按表 1 所列条件测量时，电感量;Q 值应符合条款 5。

Inductance；Q factor shall meet item 5 when measured on the condition of Table 1.

Table 1

测量设备 Measuring Equipment	RF LCR 表 E4982A 或其他 RF LCR Table E4982A or equivalen
测量频率 Measuring Frequency	见条款 5 (see item 5)
测量信号 Measuring signal level	50mV

6.2 直流电阻 DC Resistance

按表 2 所列条件测量时，直流电阻应符合条款 5。

D.C Resistance shall meet item 5 when measured on the condition of Table 2.

Table 2

测量设备 Measuring Equipment	台式毫欧表 TH2513 或其他 Desktop milliohmmeter TH2513 or equivalent

6.3 自谐频率 Self Resonant Frequency (S.R.F)

按表 3 所列条件测量时，自谐频率应符合条款 5。

S.R.F. shall meet item 5 when measured on the condition of Table 3.

Table 3

测量设备 Measuring Equipment	网络分析仪 E5071C 或其他 Network analyzer E5071C or equivalent

6.4 额定电流 Rated current

当施加允许电流（见条款 5）时，表面温度升高不超过 20℃。

Inductance change shall be within ±5% or temperature rise no more than 20℃ against chip surface temperature when the allowable current (which is mentioned in item 5) is applied.

测量设备 Measuring Equipment	直流电源，电流表，温度计 DC Power Supplier, Current Meter, Thermometer

7 信赖性试验 Reliable Performance

Item 项目	Classification 分类	Test condition	Standard
可焊性 Solderability	焊接 可靠性 Welding reliability	245 ± 5 ℃, flux 5-10 s, sample immersion tin furnace 5 ±1 s .245±5℃，助焊剂浸渍时间 5-10s，焊锡浸渍时间 5±1 s。	a. No mechanical damage be noticed. b. More than 95% of termination should be covered with new solder. 端电极焊锡覆盖率大于 95%。
耐焊性 Leaching Resistance		260±5℃,10±1s	a. No mechanical damage should be noticed. 外观不应见机械损伤 b. More than 75% of termination should be covered with new solder. 端电极焊锡覆盖率大于 75%。
*高温贮存 High Temperature Storage	环境可靠性 Environmental reliability	1.1000hrs. 125±2 ℃, 2、Unpowered. 3、Measurement at 24±4 hours after test conclusion. 1、测试 1000 小时 、125±2℃、 2、无动力（不需要通电） 3、测试结束后 24±4 小时内测量。	a. No mechanical damage should be noticed. 不应见机械损伤 b. Ferrite chip inductor: 铁氧体电感变化率： 0.001uH~10uH Δ L ≤ ± 10%,10uH 以上 ΔL ≤ ±20%, Δ Q≤±30% Inductor for high frequency: 高频电感变化率： Δ L≤±10%, Δ Q≤±20%, Chip bead: Δ Z≤±20%
*低温贮存 Low Temperature Storage	环境可靠性 Environmental reliability	1.1000hrs. -55±2 ℃, 2、Unpowered. 3、Measurement at 24±4 hours after test conclusion. 1、测试 1000 小时 、-55±2℃、 2、无动力（不需要通电） 3、测试结束后 24±4 小时内测量。	a. No mechanical damage should be noticed. 不应见机械损伤 b. Ferrite chip inductor: 铁氧体电感变化率： 0.001uH~10uH Δ L ≤ ± 10%,10uH 以上 ΔL ≤ ±20%, Δ Q≤±30% Inductor for high frequency: 高频电感变化率： Δ L≤±10%, Δ Q≤±20%, Chip bead: Δ Z≤±20%
*温度循环 Temperature Cycling	环境可靠性 Environmental reliability	1、1000 cycles (-40°C to +125°C). Note: If 85°C part or 105°C part the 1000 cycles will be at that temperature. 2、30min maximum dwell time at each temperature extreme. 1 min. maximum transition time. 3、Measurement at 24±4 hours after testconclusion. 1、1000 次循环（－40℃到 125℃） 2、在每个温度极端区最大停留时间 30 分钟，最大的过渡时间 1 分钟。 3、测试后 24±4 小时内测量。	a. No mechanical damage should be noticed. 不应见机械损伤 b. Ferrite chip inductor: 铁氧体电感变化率： 0.001uH~10uH Δ L ≤ ± 10%,10uH 以上 ΔL ≤ ±20%, Δ Q≤±30% Inductor for high frequency: 高频电感变化率： Δ L≤±10%, Δ Q≤±20%, Chip bead: Δ Z≤±20%

Item 项目	Classification 分类	Test condition 测试方法	Standard 标准
盐雾实验 Salt Spray Test	环境可靠性 Environmental reliability	1、Concentration of salt solution (5 ± 0.1) %;Temperature: 35 + 2 2、PH value: 6.5 ~ 7.2;Time: 48 + 2 h 1、盐溶液浓度：（5±0.1）%；温度:35±2 2、PH 值: 6.5~7.2；时间: 48±2h	a. No mechanical damage should be noticed. 外观不应见机械损伤 b. More than 75% of termination should be covered with new solder. 端电极焊锡覆盖率大于 75%。
* 稳态湿热 Humidity Resistance	环境可靠性 Environmental reliability	1、Temperature 温度: 85±2℃ Time 时间: 1000h 2、Humidity 湿度: （85±2） % 3、Measurement at 24±4 hours after testconclusion. 测试后 24±4 小时内测量。	a. No mechanical damage should be noticed. 不应见机械损伤 b. Ferrite chip inductor: 铁氧体电感变化率： 0.001uH~10uH Δ L ≤ ± 10%,10uH 以上ΔL ≤ ±20%, Δ Q≤ ±30% Inductor for high frequency: 高频电感变化率： Δ L≤ ±10%, Δ Q≤ ±20% Chip bead: Δ Z≤ ±20%磁珠阻抗变化率
引出端强度 Termination Strength	机械 可靠性 Mechanical reliability	1、The test samples shall be soldered to the board 2、17.64N, 60s,X,Ydirect 1、测试样品应焊接在 PCB 板上 2、推力 17.64N,60 秒,X,Y 方向	a. No mechanical damage should be noticed 不应见机械损伤 b. No open circuit parameter should be noticed. 电性参数不应出现开路
跌落 Drop	机械 可靠性 Mechanical reliability	Drop 10 times on a concrete floor from a height of 1m. 从距混凝土地面 1m 高度自由下落，重复 10 次	a. No mechanical damage should be noticed. 不应见机械损伤 b. Ferrite chip inductor: 铁氧体电感变化率： 0.001uH~10uH Δ L ≤ ± 10%,10uH 以上ΔL ≤ ±20%, Δ Q≤ ±30% Inductor for high frequency: 高频电感变化率： Δ L≤ ±10%, Δ Q≤ ±20% Chip bead: Δ Z≤ ±20% 磁珠阻抗变化率
弯曲 Board Flex	机械 可靠性 Mechanical reliability	1、The test samples shall be soldered to the board 2、 Bending speed is 1mm/s 3、Keeping the P.C Board 2 mm minimum for 60 seconds 1、将产品焊在 P.C.B 板上 2、弯曲速度是 1 毫米/秒 3、保持 PCB 板 2 毫米的最低 60 秒钟	a. No mechanical damage should be noticed. 不应见机械损伤 b. Ferrite chip inductor: 铁氧体电感变化率： 0.001uH~10uH Δ L ≤ ± 10%,10uH 以上ΔL ≤ ±20%, Δ Q≤ ±30% Inductor for high frequency: 高频电感变化率： Δ L≤ ±10%, Δ Q≤ ±20%, Chip bead: Δ Z≤ ±20%

Item 项目	Classification 分类	Test condition 测试方法	Standard 标准
振动 Vibration	机械 可靠性 Mechanical reliability	1、 Frequency range : 10~2000Hz 2、Amplitude: 1.5mm or 20 G 3、Sweep time and duration: 10~2000~10Hz for 20 minutes 4、 Each four hours(12 times) in X,Y,Z direction: 12 hours in total 1、频率范围:10～2000 赫兹 2、振幅:1.5 毫米或 20 克 3、扫描时间和持续时间:10～2000～10 赫兹 20 分钟 4、每四个小时(12 次),X,Y,Z 方向:总共 12 个小时	a. No mechanical damage should be noticed. 不应见机械损伤 b. Ferrite chip inductor: 铁氧体电感变化率： 0.001uH~10uH Δ L≤±10%,10uH 以上ΔL≤±20%, Δ Q≤±30% Inductor for high frequency: 高频电感变化率： Δ L≤±10%, Δ Q≤±20% Chip bead: Δ Z≤±20%磁珠阻抗变化率
额定电流 Rated Current	寿命 可靠性 Lifetime reliability	a. Bead: Applied current until the surface temperature rise 20℃ 磁珠：施加电流直至表面温升 20℃	a 、 Bead: The current that make the surface temperature rise 20℃ 磁珠：表面温升达到 20℃时的电流
		b. Inductor for high frequency: Applied current until the surface temperature rise 20℃ 高频电感：施加电流直至表面温升 20℃	b、Inductor for high frequency: The current that make the surface temperature rise 20℃ 高频电感：表面温升达到 20℃时的电流
		c. Ferrite inductor: Applied current until the inductance reduce 5%. 铁氧体电感：施加电流直至电感量减小 5%	c. Ferrite inductor: The rated current that make the inductance reduce 5%. 铁氧体电感：电感量降低 5%时的电流
		d、Large Current Bead: Applied current until the surface temperature rise 40℃ 大电流磁珠：施加电流直至表面温升 40℃	d、Large Current Bead: The current that make the surface temperature rise 40℃ 大电流磁珠：表面温升达到 40℃时的电流
		e、Large Current Inductor: ①Applied current until the inductance reduce 30%. ② Applied current until the surface temperature rise 40℃. 大电流电感：①施加电流直至电感量减小 30% ②施加电流直至表面温升 40℃	e、Large Current Inductor: ①The rated current that make the inductance reduce 30%. ②The current that make the surface temperature rise 40℃. 大电流电感：①电感量降低 30%时的电流 ②表面温升达到 40℃时的电流
*寿命 Operational Life	寿命 可靠性 Lifetime reliability	1、Current: applied rated current 电流：施加电流 2、Temperature 温度:85±2℃ Time 时间: 1000h 3、Measurement at 24±4 hours after testconclusion. 测试后 24±4 小时内测量。	a. No mechanical damage should be noticed. 不应见机械损伤 b. Ferrite chip inductor: 铁氧体电感变化率： 0.001uH~10uH Δ L≤±10%,10uH 以上ΔL≤±20%, Δ Q≤±30% Inductor for high frequency: 高频电感变化率： Δ L≤±10%, Δ Q≤±20%, Chip bead: Δ Z≤±20%磁珠阻抗变化率

8 焊接条件 Recommended Soldering Conditions

产品可用于波峰焊和回流焊

Product can be applied to flow and reflow soldering.

⑴ 焊剂 Flux, Solder

① 使用松香助焊剂，禁止使用卤化物含量起过 0.2wt%的强酸性助焊剂。

Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2wt% (chlorine conversion value).

② 使用纯锡焊料

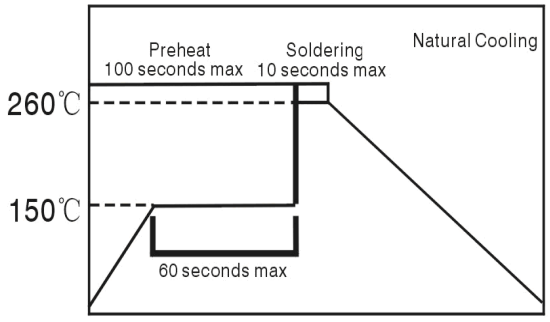
Use Sn solder.

⑵ 波峰焊条件 Flow soldering conditions

① 预热时，产品表温与焊料温度的温差最大不允许超出 150℃，焊接完后冷却时，产品表温与溶剂温度之间的温差最大不允许超出 100℃。预热不足有可能引发产品表面裂纹，导致产品品质下降。

Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150℃ max. Cooling into solvent after soldering also should be in such a way that temperature difference is limited to 100℃ max. Unwrought pre-heating may cause cracks on the product, resulting in the deterioration of products quality.

② 标准波峰焊曲线 Standard soldering profile.



预热 Pre-heating	150℃,1 minute min
最高温度 Peak	260℃,10 seconds max

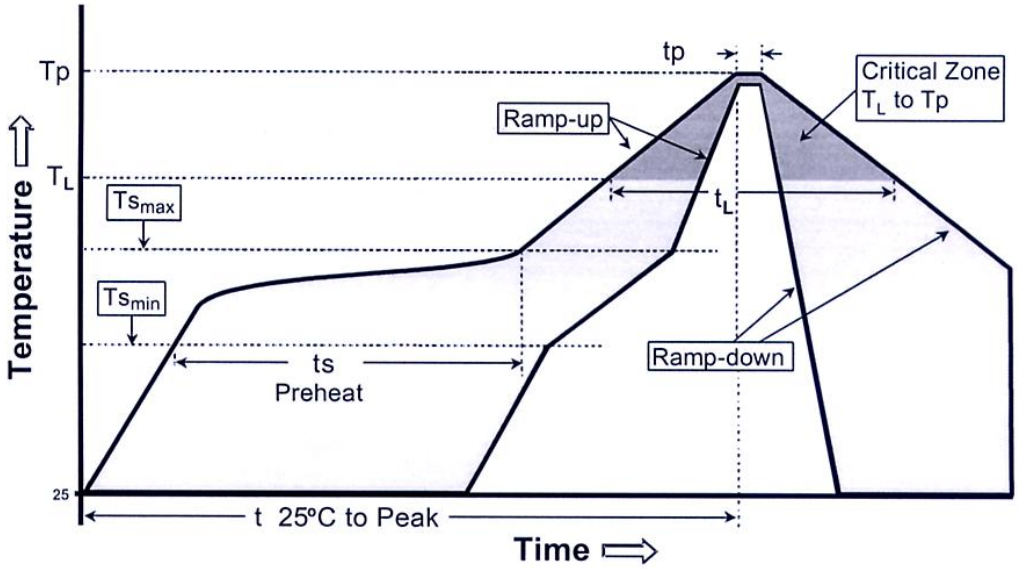
⑶ 回流焊条件 Reflow soldering conditions

Profile Feature	**Lead-Free Assembly**
Average Ramp-Up Rate (Tsmax to Tp)	3℃ C/second max.
Preheat – Temperature Min (Tsmin) – Temperature Max (Tsmax) – Time (tsmin to tsmax) min to tsmax)	150 ℃ 200 ℃ 60-180 seconds

Profile Feature	Lead-Free Assembly
Time maintained above: – Temperature (TL) – Time (tL)	217 ℃ 60-150 seconds
Peak/Classification Temperature (Tp) Peak/Classification Time (Tp)	260 ℃ 3-4 seconds
Time within 5 °C of actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	6°C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

标准回流焊曲线 Standard soldering profile



⑷ 手工返工 Reworking with soldering iron

当使用电烙铁进行手工焊接时，以下条件必须严格遵守

The following conditions must be strictly followed when using a soldering iron.

预热 Pre-heating	150℃, 1 minute
尖端温度 Tip temperature	350℃ max
输出功率 Soldering iron output	80w max
电烙铁头尖端尺寸 End of soldering iron	Φ 1mm max
焊接时间 Soldering time	3 seconds max

9 清洗条件 Cleaning Conditions

产品清洗时应遵循以下条件

Products shall be cleaned on the following conditions.

⑴ 清洗温度最高不超过 60℃。（若是氟化物类和酒精类清洁剂，温度最高不超过 40℃）

Cleaning temperature shall be limited to 60℃ max.(40℃ max for fluoride and alcohol type cleaner.)

⑵ 为了避免印刷线路板及其上所安装器件出现共振现象，在进行超声波清洗时，应严格遵循以下条件

Ultrasonic cleaning shall comply with the following conditions with avoiding the resonance phenomenon at the mounted products and P.C.B.

功率 Power : 20W/t max

频率 Frequency: 40 kHz 以下

时间 Time : 5 minutes max

⑶ 清洁剂 Cleaner

a) 可选类型 Alternative cleaner

异丙基醇 Isopropyl alcohol (IPA) HCFC-225

b) 含水剂 Aqueous agent

表面活性剂类 Surface Active Agent Type (CLEANTHROUGH 750H)

碳氢化合物类 Hydrocarbon Type (TECHNOCLEANER 335)

高分子醇类 Higher Alcohol Type (PINE ALPHA ST-100S)

碱性皂类 Alkali Saponification Type (*AQUACLEANER 240)

⑷ 清洗后，产品上不应有助焊剂和清洁剂驻留；若使用了含水剂，为了彻底洗去清洁剂，产品应在去离子水冲洗后完全晾干或烘干。

Thee shall be no residual flux and residual cleaner after cleaning. In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.

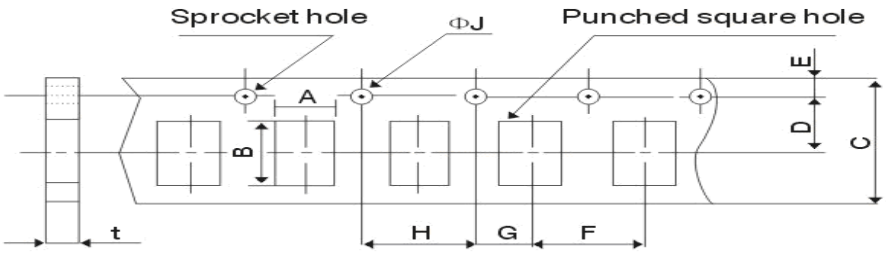
⑸ 其他清洁方式 Other cleaning

请联系我们 Please contact us.

10 包装 Packaging

⑴ 编带尺寸 Dimensions of Tape:

纸带/塑带 Paper / Embossed carrier tape:

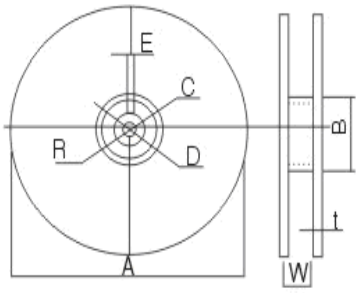


Unit: mm

Type	0603
T*	0.4±0.03
	Paper carrier tape
A	0.4±0.05
B	0.7±0.05
C	8.0±0.3
D	3.5±0.05
E	1.75±0.1
F	2.0±0.05
G	2.0±0.05
H	4.0±0.1
ΦJ	1.5+0.1/-0
t(max)	0.55±0.05

T*：Product thickness

⑵ 带轮尺寸 Dimensions of Reel



Reel material: PS (Polystyrene)

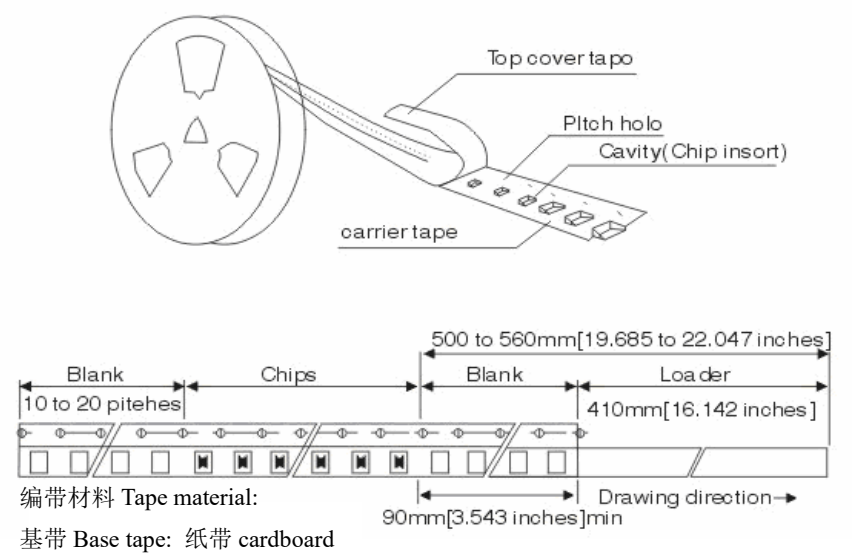
Unit: mm

A	178±2
B	60±2
C	13.0±0.5
D	21.0±0.8
E	2.0±0.5
W	10.0±1.15
t	1.2±0.2
R	1.0±0.25

⑶ 编带抗拉强度 Pulling strength of tapes

载带 Carrier tape	10N or more (1kgf or more)
上盖带 Cover tape	5N or more (0.5kgf or more)

⑷ 编带简图及拉伸方向 Taping figure and drawing direction



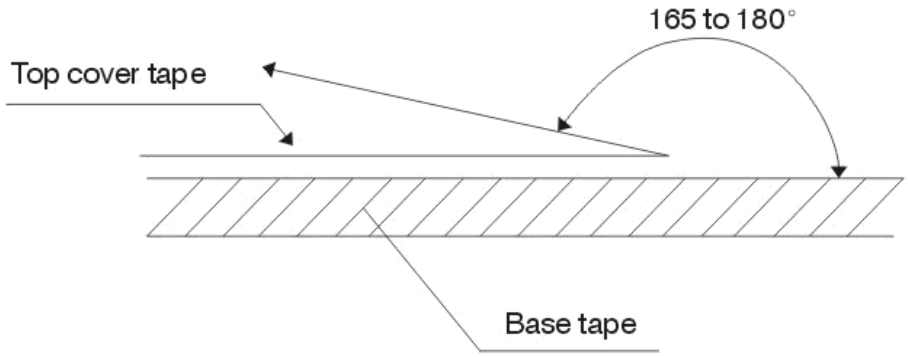
编带材料 Tape material:

基带 Base tape: 纸带 cardboard

盖带 Cover tape: 聚乙烯 polyethylene

⑸ 盖带剥离强度 Peeling strength of cover tape

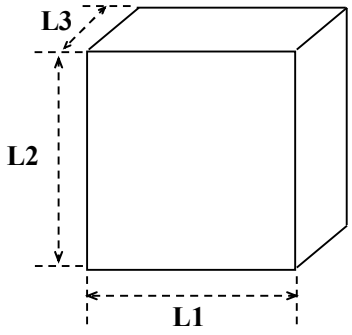
盖带 Cover tape	0.3~0.7N (30gf~70gf)



测试条件 Test condition:

1) 剥离角度 peel angle: 165°~180° vs. carrier tape.
2) 剥离速度 peel speed: 300 mm/min±10%.

⑹ 包装箱盒尺寸 Box and case dimensions



Unit: mm

Type	L1	L2	L3
Box	180±2	180±2	75±1
Box	180±2	180±2	120±2
Case	400±2	400±2	200±2

A 一盒六盘，一箱十盒 6 reels in a box.

B 一盒十盘，一箱六盒 10 boxes in a case.

⑺ 包装数量 Packaging quantities

Type	Thickness(mm)	Bulk	Tape and reel
0603	0.4±0.03	----	15000pcs

11 装箱清单及标志 Packing documents and marking

⑴ 包装文件 Packing documents

Packing includes the following:

a. 装箱清单 Packing list.

b. 合格证书 Certificate of compliance.

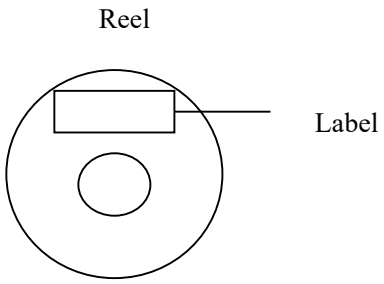
⑵ 盘上标记 Marking on reels:

a 型号 MICROGATE Part No.

b 生产批号 Lot number

c 盘装数量 Quantity per reel

d 检验员号 Inspector No.



以上内容必须在标签上注明.All above shall be shown on marking label

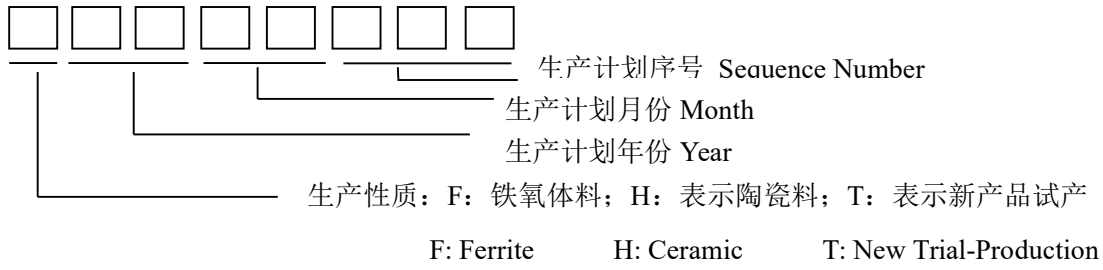
麦捷公司标签如下所示：MICROGATE marking label will be as following:

MICROGATE

CUSTOMER:	P. O. NO	
CUSTOMER PART NO:	DATE CODE	LOT NO
MG PART NO:	QUANTITY	INSP. NO

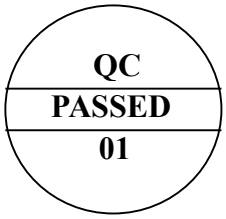
MG PART NO

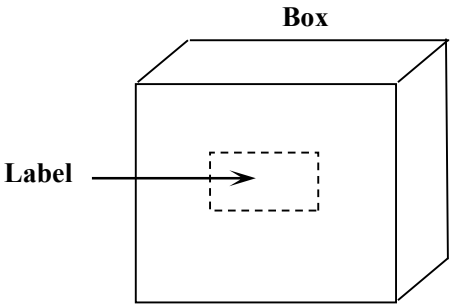
麦捷公司生产编号如下列所示:MICROGATE Lot number will be as per the following example:



检验合格后，检验员在标签上盖上合格章。合格章如下所示：

The eligible reels will be pressed a mark onto the surface. The mark will be as following:





⑶ 内包装盒标记:Marking on inner box

a 型号 MICROGATE Part No.

b 每盒数量 Quantity per box

c 包装日期 Date

以上内容必须在标签上注明（标签见 11.2 所示）。

Above shall be shown on marking label(The marking label is shown in item 11.2).

⑷ 外包装箱标记 Marking on outer case:

1) 制造商 Manufacturer: “MICROGATE” will be marked on ①

“中国深圳制造” “Made in Shenzhen CHINA” will be marked on ②

2) 发运标记 Ship marking:

“向上” “UP”, “小心轻放”“HAND CARE”, “防潮”“MOISTURE-PROOF” will be marked on 2).

3) 包装标签包括以下内容 Packing label include the following:

a. 型号 MICROGATE Part No

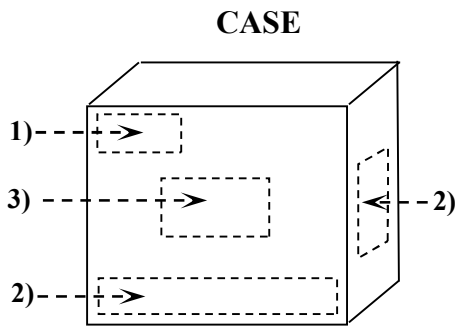
b. 总数量 Total quantity per case

c. 包装日期 Date;

以上内容必须在标签上注明。(标签见 11.2 所示)

All above shall be shown on marking label.

(The marking label is shown in item 11.2)



12 保管 Storage

⑴ 保管期限 Storage period

距麦捷出厂检验时间六个月内，产品可以使用；检验时间可以通过包装外侧标记的检验号确认；若时间超出六个月，应检查焊接性能后方可使用。

Products which inspected in MICROGATE over 6 months ago should be examined and used, which can be confirmed with inspection No. marked on the container. Solder ability should be checked if this period is exceeded.

⑵ 保管条件 Storage conditions

① 存放货物的库房应满足以下条件

Products should be storage in the warehouse on the following conditions

温度 Temperature: ≦40℃

湿度 Humidity : ≦70% relative humidity

不允许温、湿度有极剧变化。

No rapid change on temperature and humidity

② 禁止将产品保管在腐蚀性物质中，例如硫磺、氯气或者酸，否则将引起端头氧化，导致降低焊接性。

Don’t keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solder ability.

③ 为了避免受潮气、灰尘等物质的影响，产品应保管于货架上。

Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.

④ 产品保管在库房中时，应避免热冲击，振动以及直接光照等等。

Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.

⑤ 产品应密封包装

Products should be storage under the airtight packaged condition.

13 溴素系难燃剂的使用情况 Usage of Nonflammable Material

对于以下所列物质，我司在生产过程中绝不使用，最终成品中也绝不含用。

For these materials listed below, we don't use in process.

镉、汞、砷及其化合物，PCB 等等。Cd, Hg, As and its compound, PCB, etc.

PBBS, PBBOs, PBDO, PBDE, PBB.

14 ODS 的使用情况 Usage of ODS

对于以下所列的 ODS 物质，我司在生产过程中绝不使用，最终成品中也绝不含有。

For ODS listed below, we don't use in process.

四氧化碳，HCFC 等等。ODS: CCL_4, HCFC, etc. ODS。

15 阻燃级别 Flammability Class

UL 94V-1

16 注意事项 Note

①.本纳入仕样书保证我司产品作为一个单体时的质量情况。当我司产品被安装到贵司产品上时，请保证贵司的产品已根据贵司的规范进行了有效评价和确认。

This product specification guarantees the quality of our product as a single unit. Please make sure that your product is evaluated and confirmed against your specifications when our product is mounted to your product.

②．如果贵司对我司产品的使用已超过了本测试规范所界定的产品功能，那么对于由此引发的失效，我司将不予保证。

We cannot warrant against failure caused by any use of our product that deviates from the intended use as described in this product specification.

③．请加盖接受同意章，并在本测试规范提交日后两个月内传回或寄回复印件。如果在以上期限内未收到复印件，将被默认为已被接受。

Please return our copy of this product specification in two month after issued date with your signature of receipt. If the copy is not returned by the date, this product specification will be deemed to have been received.